

## 12-BIT, 50MSPS, 150mW A/D CONVERTER

- 40mW @ 5Msps, 150mW @ 50Msps
- 2.5V supply voltage with 2.5V/3.3V compatibility for digital I/O
- Input range: 2Vpp differential
- SFDR up to 77dB @ 50Msps, Fin=15MHz
- ENOB up to 10.5 bits @ 50Msps, Fin=15MHz
- Built-in reference voltage with external bias capability
- Pinout compatibility with TSA0801, TSA1001 and TSA1002

## DESCRIPTION

The TSA1201 is a 12-bit, 50MHz maximum sampling frequency Analog to Digital converter using a CMOS technology combining high performances and very low power consumption.

The TSA1201 is based on a pipeline structure and digital error correction to provide excellent static linearity and achieve 10.5 effective bits at  $F_s=50\text{Msps}$ , and  $F_{in}=15\text{MHz}$ , with a global power consumption of 150mW.

The TSA1201 features adaptive behavior to the application. Its architecture allows to sample from 0.5Msps up to 50Msps, with a programmable power consumption which makes the application board even more optimized.

It integrates a proprietary track-and-hold structure to ensure a high analog bandwidth of 1GHz and enable IF-sampling.

Several features are available on the device. A voltage reference is integrated in the circuit. Differential or single-ended analog inputs can be applied. The output data can be coded into two differential formats. A Data Ready signal is raised as the data is valid on the output and can be used for synchronization purposes.

The TSA1201 is available in extended (-40°C to +85°C) temperature range, in small 48 pins TQFP package.

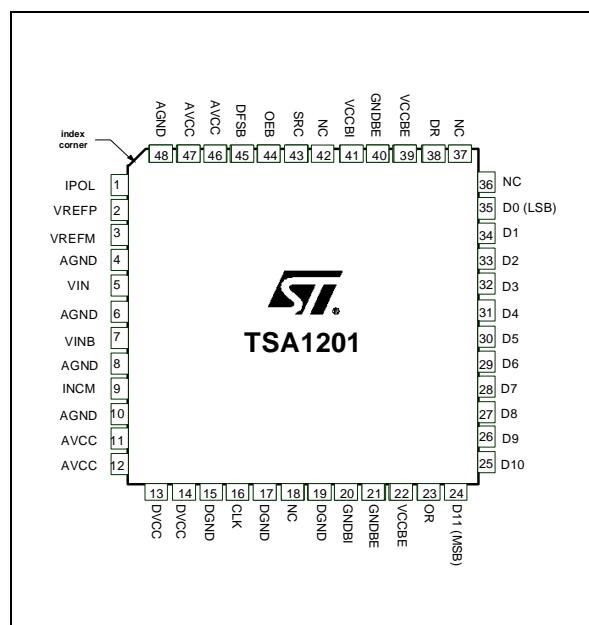
## APPLICATIONS

- High speed data acquisition
- High End cameras
- Medical imaging and ultrasound
- Portable instrumentation
- High speed DSP interface
- Digital communication - IF sampling

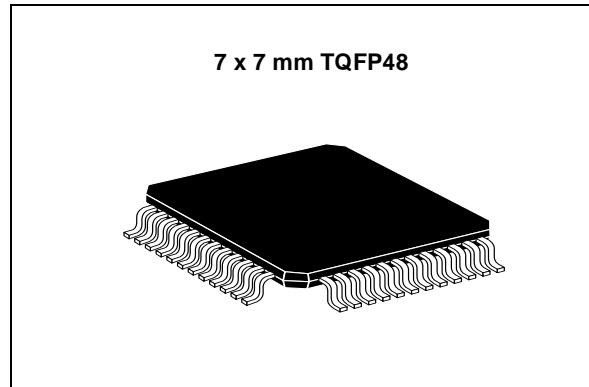
## ORDER CODE

Part Number	Temperature Range	Package	Conditioning	Marking
TSA1201IF	-40°C to +85°C	TQFP48	Tray	SA1201I
TSA1201IFT	-40°C to +85°C	TQFP48	Tape & Reel	SA1201I
EVAL1201/AA	Evaluation board			

## **PIN CONNECTIONS** (top view)



## PACKAGE



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Values	Unit
AVCC	Analog Supply voltage <sup>1)</sup>	0 to 3.3	V
DVCC	Digital Supply voltage <sup>1)</sup>	0 to 3.3	V
VCCBI	Digital buffer Supply voltage <sup>1)</sup>	0 to 3.3	V
VCCBE	Digital buffer Supply voltage <sup>1)</sup>	0 to 3.6	V
Tstg	Storage temperature	+150	°C
ESD	Electrical Static Discharge - HBM - CDM-JEDEC Standard	2 1.5	kV

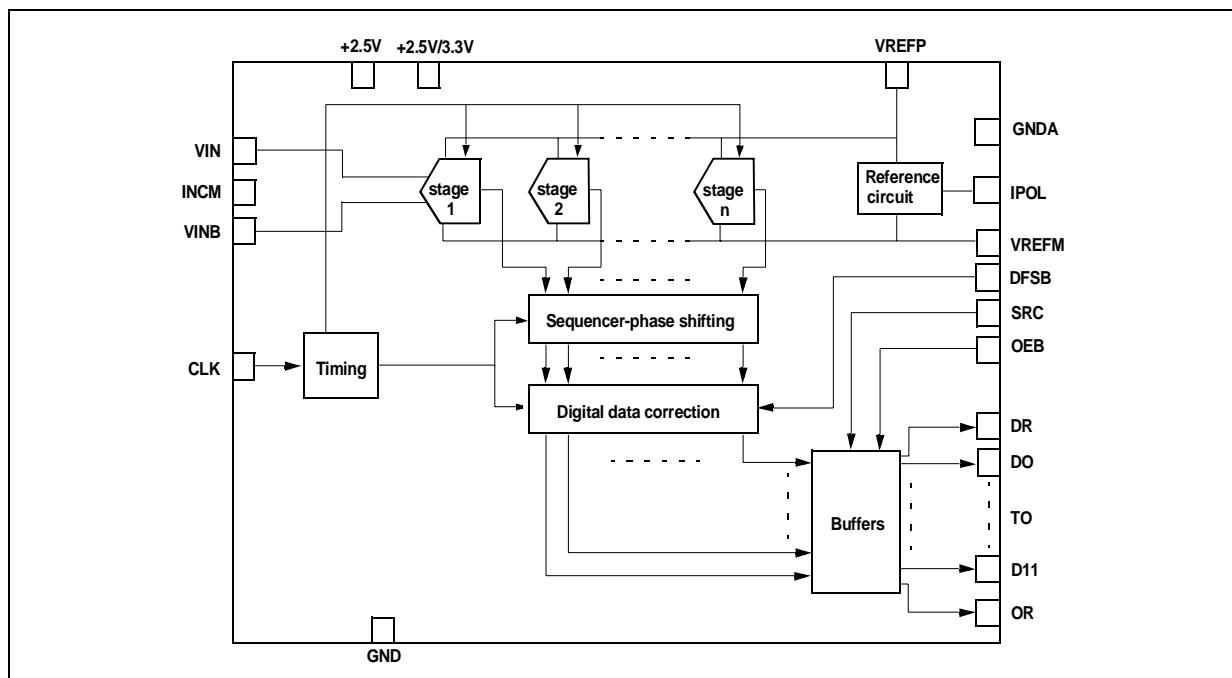
1. All voltages values, except differential voltage, are with respect to network ground terminal. The magnitude of input and output voltages must never exceed -0.3V or VCC+0V

## OPERATING CONDITIONS

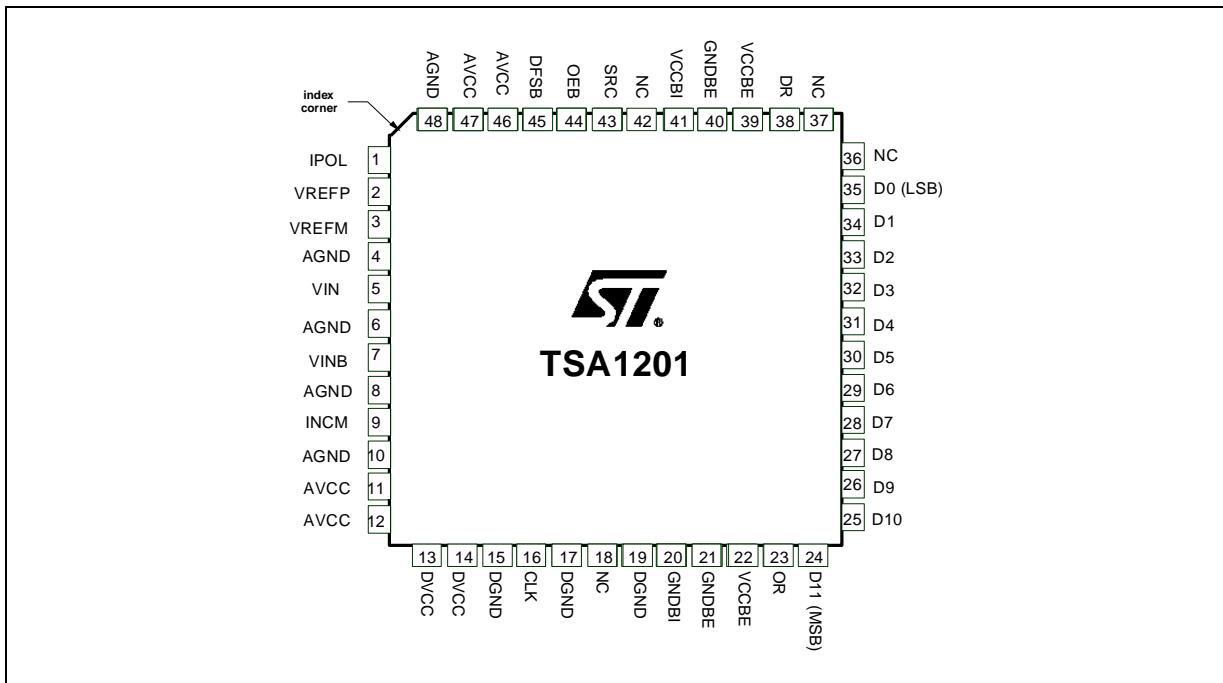
Symbol	Parameter	Min	Typ	Max	Unit
AVCC	Analog Supply voltage	2.25	2.5	2.7	V
DVCC	Digital Supply voltage	2.25	2.5	2.7	V
VCCBI	Internal buffer Supply voltage	2.25	2.5	2.7	V
VCCBE	External buffer Supply voltage	2.25	2.5	3.5	V
VREFP	Forced top reference voltage <sup>1)</sup>	0.5	1	1.8	V
VREFM	Forced bottom reference voltage <sup>1)</sup>	0	0	0.5	V
INCM	Forced input common mode voltage	0.2	0.5	1.1	V

1) Condition VRefP-VRefM>0.3V

## BLOCK DIAGRAM



## PIN CONNECTIONS (top view)



## PIN DESCRIPTION

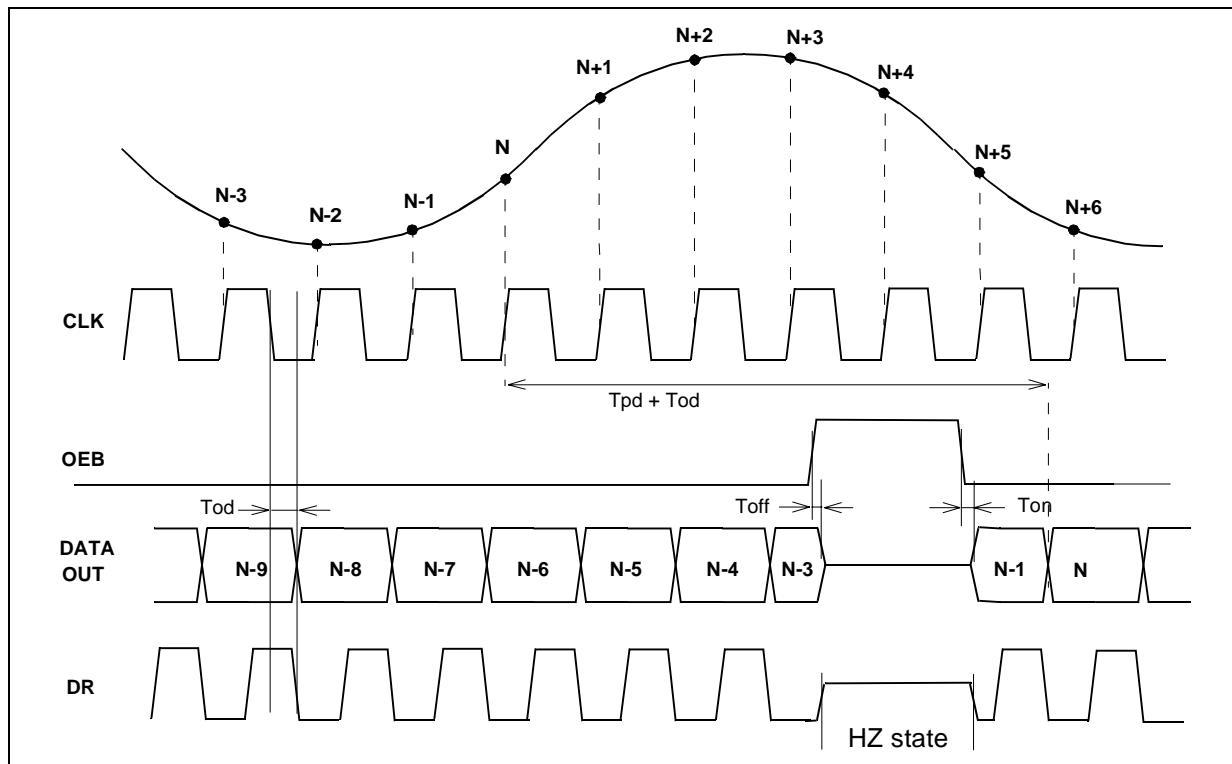
Pin No	Name	Description	Observation	Pin No	Name	Description	Observation
1	IPOL	Analog bias current input		25	D10	Digital output	CMOS output (2.5V/3.3V)
2	VREFP	Top voltage reference	1V	26	D9	Digital output	CMOS output (2.5V/3.3V)
3	VREFM	Bottom voltage reference	0V	27	D8	Digital output	CMOS output (2.5V/3.3V)
4	AGND	Analog ground	0V	28	D7	Digital output	CMOS output (2.5V/3.3V)
5	VIN	Analog input	1Vpp	29	D6	Digital output	CMOS output (2.5V/3.3V)
6	AGND	Analog ground	0V	30	D5	Digital output	CMOS output (2.5V/3.3V)
7	VINB	Inverted analog input	1Vpp	31	D4	Digital output	CMOS output (2.5V/3.3V)
8	AGND	Analog ground	0V	32	D3	Digital output	CMOS output (2.5V/3.3V)
9	INCM	Input common mode	0.5V	33	D2	Digital output	CMOS output (2.5V/3.3V)
10	AGND	Analog ground	0V	34	D1	Digital output	CMOS output (2.5V/3.3V)
11	AVCC	Analog power supply	2.5V	35	D0(LSB)	Least Significant Bit output	CMOS output (2.5V/3.3V)
12	AVCC	Analog power supply	2.5V	36	NC	Non connected	
13	DVCC	Digital power supply	2.5V	37	NC	Non connected	
14	DVCC	Digital power supply	2.5V	38	DR	Data Ready output	CMOS output (2.5V/3.3V)
15	DGND	Digital ground	0V	39	VCCBE	Digital Buffer power supply	2.5V/3.3V
16	CLK	Clock input	2.5V compatible CMOS input	40	GNDI	Digital Buffer ground	0V
17	DGND	Digital ground	0V	41	VCCBI	Digital Buffer power supply	2.5V
18	NC	Non connected		42	NC	Non connected	
19	DGND	Digital ground	0V	43	SRC	Slew rate control input	2.5V/3.3V CMOS input
20	GNDI	Digital buffer ground	0V	44	OEB	Output Enable input	2.5V/3.3V CMOS input
21	GNDI	Digital buffer ground	0V	45	DFSB	Data Format Select input	2.5V/3.3V CMOS input
22	VCCBE	Digital buffer power supply	2.5V/3.3V	46	AVCC	Analog power supply	2.5V
23	OR	Out Of Range output	CMOS output (2.5V/3.3V)	47	AVCC	Analog power supply	2.5V
24	D11(MSB)	Most Significant Bit output	CMOS output (2.5V/3.3V)	48	AGND	Analog ground	0V

**CONDITIONS**

AVCC = DVCC = VCCBE = VCCBI = 2.5V,  $F_s = 50\text{Msps}$ ,  $F_{in} = 2\text{MHz}$ ,  $V_{in} @ -1\text{dBFS}$ ,  $V_{REFM} = 0\text{V}$   
 $T_{amb} = 25^\circ\text{C}$  (unless otherwise specified)

**TIMING CHARACTERISTICS**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
FS	Sampling Frequency		0.5		50	MHz
DC	Clock Duty Cycle		45	50	55	%
TC1	Clock pulse width (high)		9	10		ns
TC2	Clock pulse width (low)		9	10		ns
Tod	Data Output Delay (Fall of Clock to Data Valid)	6pF load capacitance		8		ns
Tpd	Data Pipeline delay			5.5		cycles
Ton	Falling edge of OEB to digital output valid data			1		ns
Toff	Rising edge of OEB to digital output tri-state			1		ns

**TIMING DIAGRAM**

**CONDITIONS**

AVCC = DVCC = VCCBE = VCCBI = 2.5V,  $F_s = 50\text{Msps}$ ,  $F_{in} = 2\text{MHz}$ ,  $V_{in} @ -1\text{dBFS}$ ,  $V_{REFM} = 0\text{V}$   
 Tamb = 25°C (unless otherwise specified)

**ANALOG INPUTS**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
VIN-VINB	Full scale reference voltage			2.0		V <sub>pp</sub>
C <sub>in</sub>	Input capacitance			7.0		pF
R <sub>req</sub>	Differential input resistance			5		kΩ
BW	Analog Input Bandwidth	V <sub>in</sub> @ Full Scale, $F_s = 50\text{Msps}$		1000		MHz
ERB	Effective Resolution Bandwidth <sup>1)</sup>			90		MHz

1. See parameters definition for more information.

**REFERENCE VOLTAGE**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
V <sub>REFP</sub>	Top internal reference voltage		0.79	1.0	1.16	V
		T <sub>min</sub> = -40°C to T <sub>max</sub> = 85°C <sup>1)</sup>	0.79		1.16	V
V <sub>pol</sub>	Analog bias voltage		1.08	1.15	1.22	V
		T <sub>min</sub> = -40°C to T <sub>max</sub> = 85°C <sup>1)</sup>	1.07		1.23	V
V <sub>INCM</sub>	Input common mode voltage		0.40	0.55	0.65	V
		T <sub>min</sub> = -40°C to T <sub>max</sub> = 85°C <sup>1)</sup>	0.4		0.65	V

1. Not fully tested over the temperature range. Guaranteed by sampling.

**CONDITIONS**AVCC = DVCC = VCCBE = VCCBI = 2.5V,  $F_s = 50\text{Msps}$ ,  $F_{in} = 2\text{MHz}$ ,  $V_{in} = -1\text{dBFS}$ ,  $V_{REFP} = 1\text{V}$ , $V_{REFM} = 0\text{V}$  $T_{amb} = 25^\circ\text{C}$  (unless otherwise specified)**POWER CONSUMPTION**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
ICCA	Analog Supply current	1) $T_{min} = -40^\circ\text{C}$ to $T_{max} = 85^\circ\text{C}$ <sup>2)</sup>		46	51	mA
					55	mA
ICCD	Digital Supply Current	1) $T_{min} = -40^\circ\text{C}$ to $T_{max} = 85^\circ\text{C}$ <sup>2)</sup>		1.9	2.2	mA
					2.2	mA
ICCB1	Digital Buffer Supply Current	1) $T_{min} = -40^\circ\text{C}$ to $T_{max} = 85^\circ\text{C}$ <sup>2)</sup>		0.3	0.4	mA
					0.4	mA
ICCB2	Digital Buffer Supply Current	1) $T_{min} = -40^\circ\text{C}$ to $T_{max} = 85^\circ\text{C}$ <sup>2)</sup>		9.8	10.8	mA
					10.8	mA
ICCBZ	Digital Buffer Supply Current in High Impedance Mode			4	5	mA
Pd	Power consumption in normal operation mode	1) $T_{min} = -40^\circ\text{C}$ to $T_{max} = 85^\circ\text{C}$ <sup>2)</sup>		150	158	mW
					165	mW
Rthja	Junction-ambient thermal resistance (TQFP48)			80		°C/W

1. Equivalent load:  $R_{load} = 470\Omega$  and  $C_{load} = 6\text{pF}$ 

2. Not fully tested over the temperature range. Guaranteed by sampling.

**DIGITAL INPUTS AND OUTPUTS**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
<b>Clock input</b>						
VIL	Logic "0" voltage			0	0.8	V
VIH	Logic "1" voltage		2.0	2.5		V
<b>Digital inputs</b>						
VIL	Logic "0" voltage			0	0.25 x VCCBE	V
VIH	Logic "1" voltage		0.75 x VCCBE	VCCBE		V
<b>Digital Outputs</b>						
VOL	Logic "0" voltage	$I_{ol} = 10\mu\text{A}$		0	0.1 x VCCBE	V
VOH	Logic "1" voltage	$I_{oh} = 10\mu\text{A}$	0.9 x VCCBE	VCCBE		V
IOZ	High Impedance leakage current	OEB set to VIH	-2.5		2.5	μA
CL	Output Load Capacitance				15	pF

**CONDITIONS**

AVCC = DVCC = VCCBE = VCCBI = 2.5V,  $F_s$  = 50Msps,  $V_{in}$  @ -1dBFS,  $V_{REFP}$  = 1V,  $V_{REFM}$  = 0V  
 Tamb = 25°C (unless otherwise specified)

**ACCURACY**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
OE	Offset Error	$F_{in}$ = 2MHz, $V_{in}$ @ +1dBFS		2.45		mV
DNL	Differential Non Linearity	$F_{in}$ = 2MHz, $V_{in}$ @ +1dBFS		$\pm 0.6$		LSB
INL	Integral Non Linearity	$F_{in}$ = 2MHz, $V_{in}$ @ +1dBFS		$\pm 1.7$		LSB
-	Monotonicity and no missing codes	Guaranteed				

**DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
SFDR	Spurious Free Dynamic Range	$F_{in}$ = 15MHz <sup>1)</sup>		-77.2	-68	dBc
		$F_{in}$ = 15MHz <sup>2)</sup>			-67	dBc
SNR	Signal to Noise Ratio	$F_{in}$ = 15MHz <sup>1)</sup>	61.6	64.9		dB
		$F_{in}$ = 15MHz <sup>2)</sup>	60.7			dB
THD	Total Harmonics Distortion	$F_{in}$ = 15MHz <sup>1)</sup>		-74.3	-68	dB
		$F_{in}$ = 15MHz <sup>2)</sup>			-64	dB
SINAD	Signal to Noise and Distortion Ratio	$F_{in}$ = 15MHz <sup>1)</sup>	61	64.4		dB
		$F_{in}$ = 15MHz <sup>2)</sup>	60			dB
ENOB	Effective Number of Bits	$F_{in}$ = 15MHz <sup>1)</sup>	10	10.5		bits
		$F_{in}$ = 15MHz <sup>2)</sup>	9.9			bits

1. Equivalent load:  $R_{load}$  = 470Ω and  $C_{load}$  = 6pF

2.  $T_{min}$  = -40°C to  $T_{max}$  = 85°C. Not fully tested over the temperature range. Guaranteed by sampling.

**DEFINITIONS OF SPECIFIED PARAMETERS****STATIC PARAMETERS**

Static measurements are performed through method of histograms on a 2MHz input signal, sampled at 50Msps, which is high enough to fully characterize the test frequency response. The input level is +1dBFS to saturate the signal.

**Differential Non Linearity (DNL)**

The average deviation of any output code width from the ideal code width of 1LSB.

**Integral Non linearity (INL)**

An ideal converter presents a transfer function as being the straight line from the starting code to the ending code. The INL is the deviation for each transition from this ideal curve.

**DYNAMIC PARAMETERS**

Dynamic measurements are performed by spectral analysis, applied to an input sinewave of various frequencies and sampled at 50Msps.

**Spurious Free Dynamic Range (SFDR)**

The ratio between the power of the worst spurious signal (not always an harmonic) and the amplitude of fundamental tone (signal power) over the full Nyquist band. It is expressed in dBc.

**Total Harmonic Distortion (THD)**

The ratio of the rms sum of the first five harmonic distortion components to the rms value of the fundamental line. It is expressed in dB.

**Signal to Noise Ratio (SNR)**

The ratio of the rms value of the fundamental component to the rms sum of all other spectral components in the Nyquist band ( $f_s/2$ ) excluding DC, fundamental and the first five harmonics. SNR is reported in dB.

**Signal to Noise and Distortion Ratio (SINAD)**

Similar ratio as for SNR but including the harmonic distortion components in the noise figure (not DC signal). It is expressed in dB.

From the SINAD, the Effective Number of Bits (ENOB) can easily be deduced using the formula:  $SINAD = 6.02 \times ENOB + 1.76$  dB.

When the applied signal is not Full Scale (FS), but has an  $A_0$  amplitude, the SINAD expression becomes:

$SINAD = 6.02 \times ENOB + 1.76$  dB +  $20 \log (2A_0/FS)$   
The ENOB is expressed in bits.

**Analog Input Bandwidth**

The maximum analog input frequency at which the spectral response of a full power signal is reduced by 3dB. Higher values can be achieved with smaller input levels.

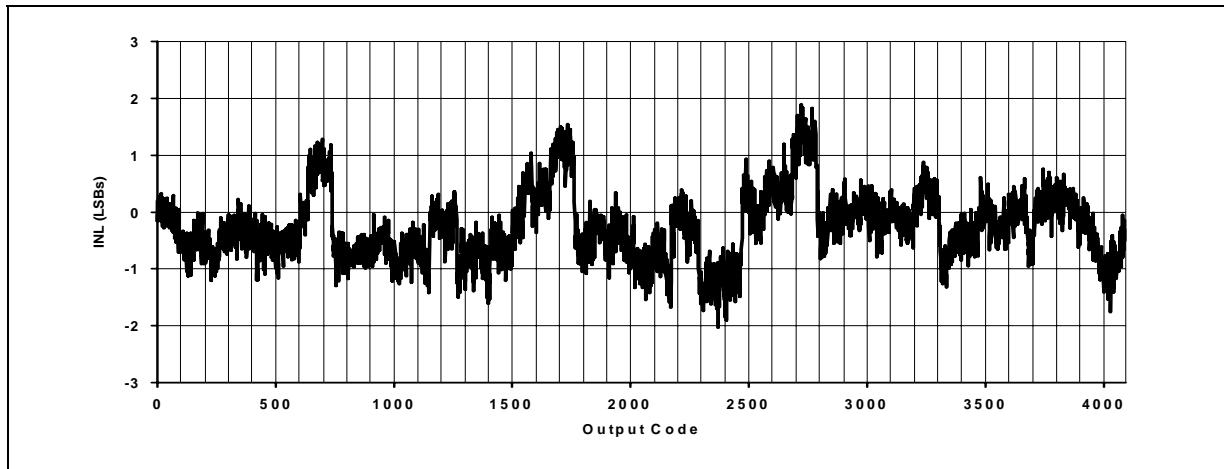
**Effective Resolution Bandwidth (ERB)**

The band of input signal frequencies that the ADC is intended to convert without loosing linearity i.e. the maximum analog input frequency at which the SINAD is decreased by 3dB or the ENOB by 1/2 bit.

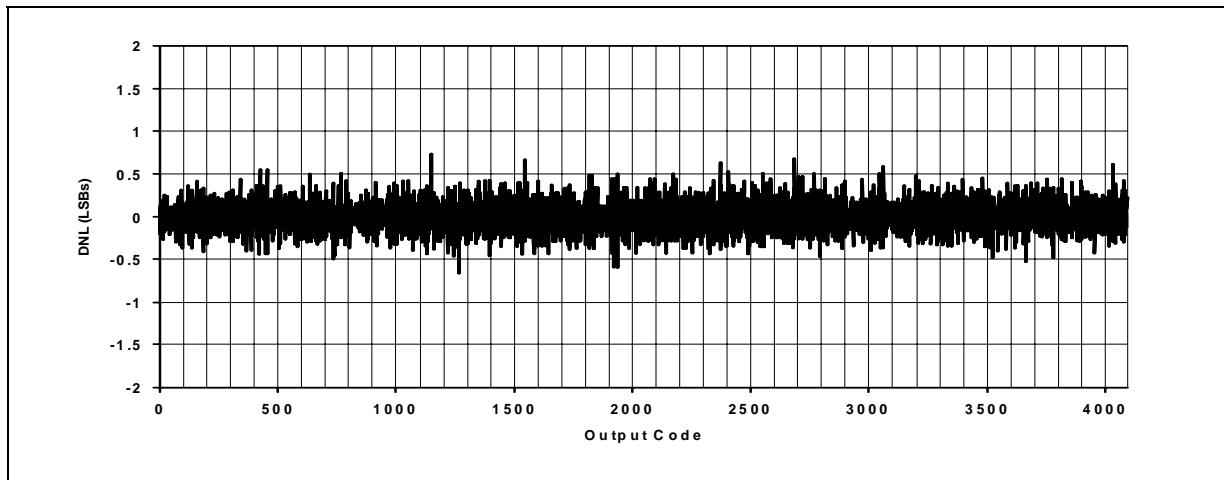
**Pipeline delay**

Delay between the initial sample of the analog input and the availability of the corresponding digital data output, on the output bus. Also called data latency. It is expressed as a number of clock cycles.

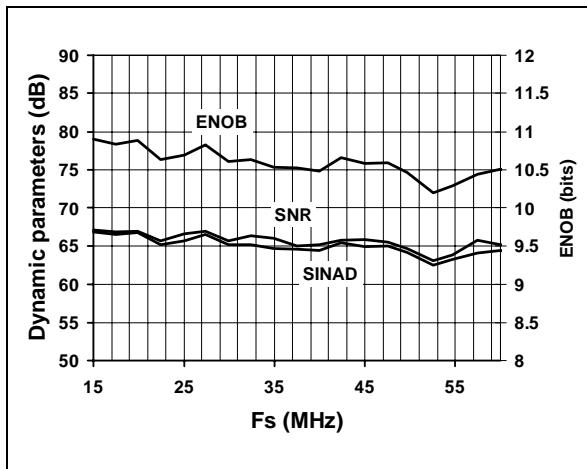
**Static parameter: Integral Non Linearity**  
 Fs=50MSPS; Fin=1MHz; Icca=45mA; N=131072pts



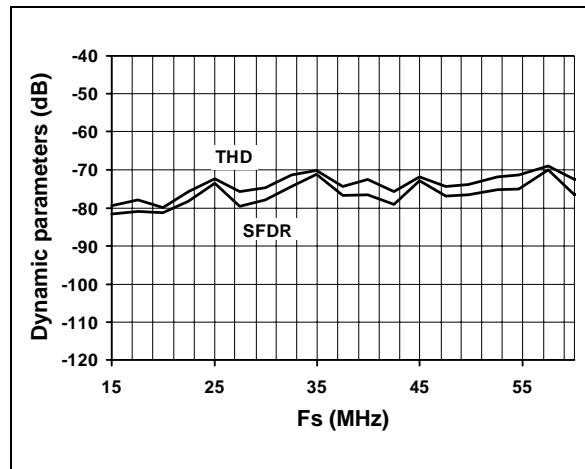
**Static parameter: Differential Non Linearity**  
 Fs=50MSPS; Fin=1MHz; Icca=45mA; N=131072pts



**Linearity vs. Fs**  
 Fin=10MHz; Rpol adjustment

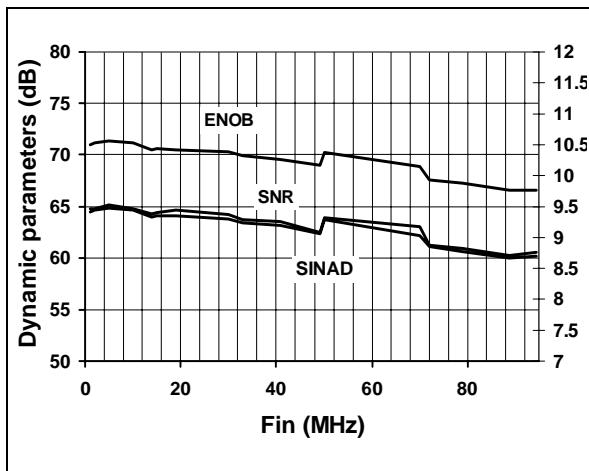


**Distortion vs. Fs**  
 Fin=10MHz; Rpol adjustment



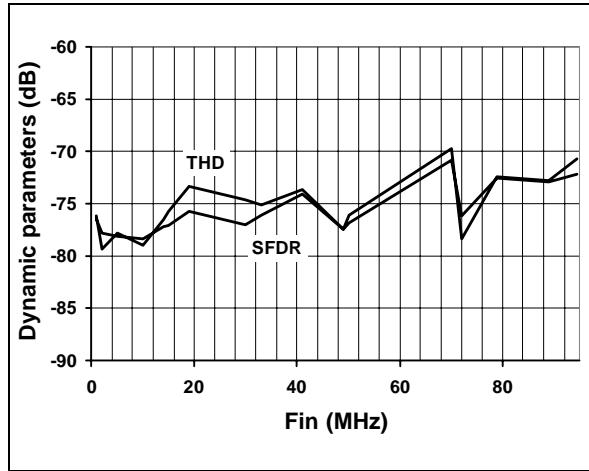
**Linearity vs. Fin**

Fs=50MHz; Icca=45mA



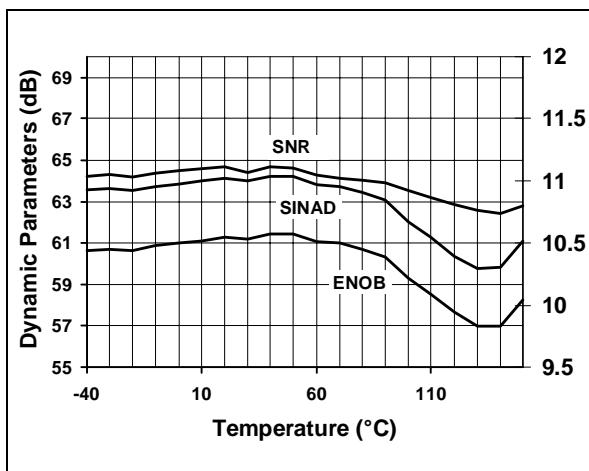
**Distortion vs. Fin**

Fs=50MHz; Icca=45mA



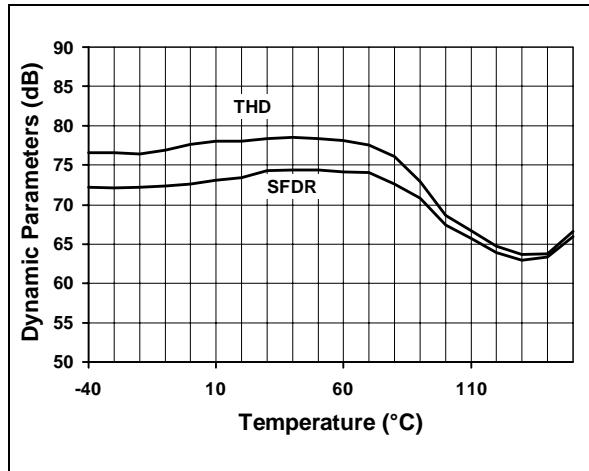
**Linearity vs. Temperature**

Fs=49.7MSPS; Icca=45mA; Fin=15MHz



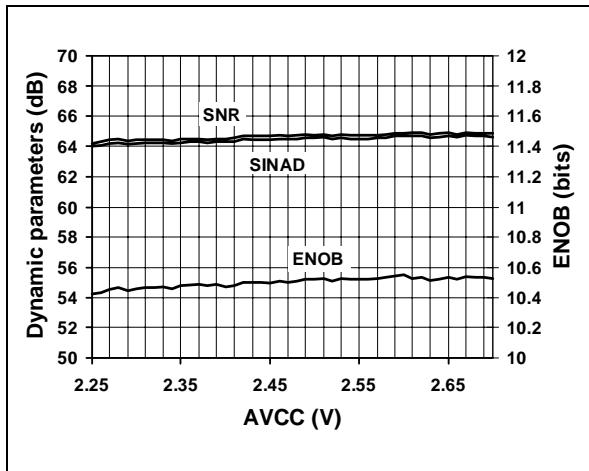
**Distortion vs. Temperature**

Fs=49.7MSPS; Icca=45mA; Fin=15MHz



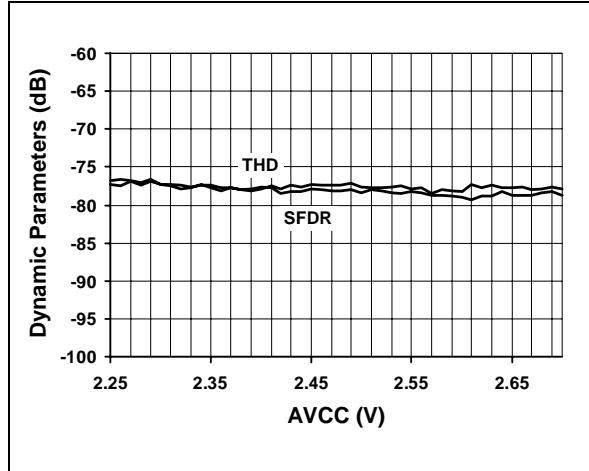
**Linearity vs. AVCC**

Fs=50MSPS; Icca=45mA; Fin=10MHz



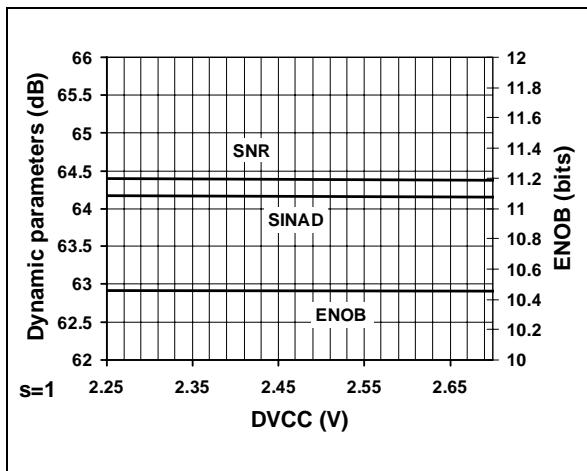
**Distortion vs. AVCC**

Fs=50MSPS; Icca=45mA; Fin=10MHz

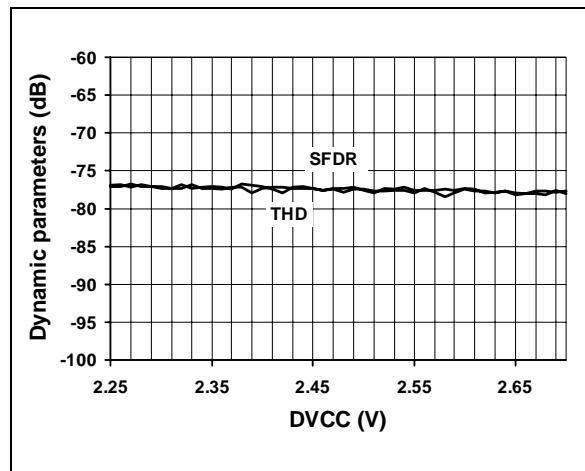


**Linearity vs. DVCC**

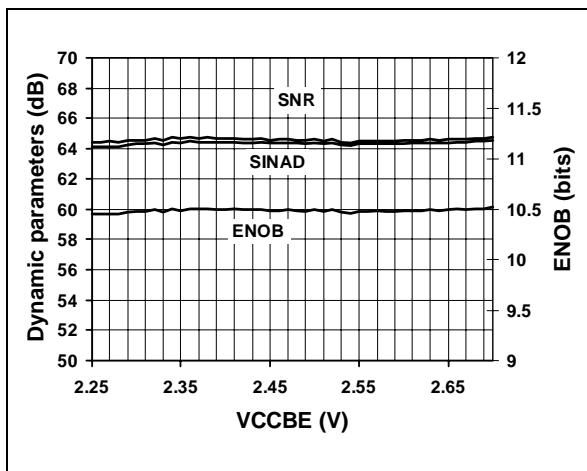
Fs=50MSPS; Icca=45mA; Fin=10MHz

**Distortion vs. DVCC**

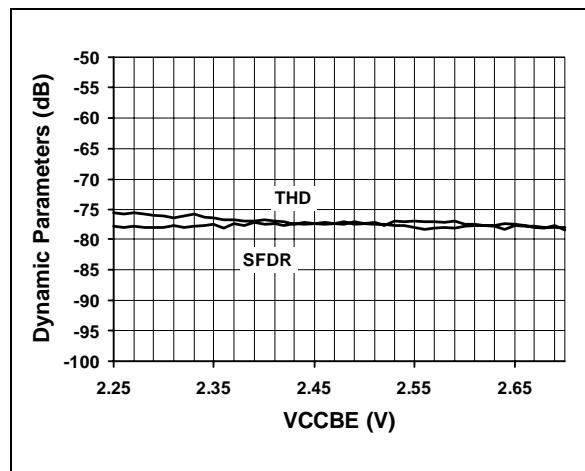
Fs=50MSPS; Icca=45mA; Fin=10MHz

**Linearity vs. VCCBE**

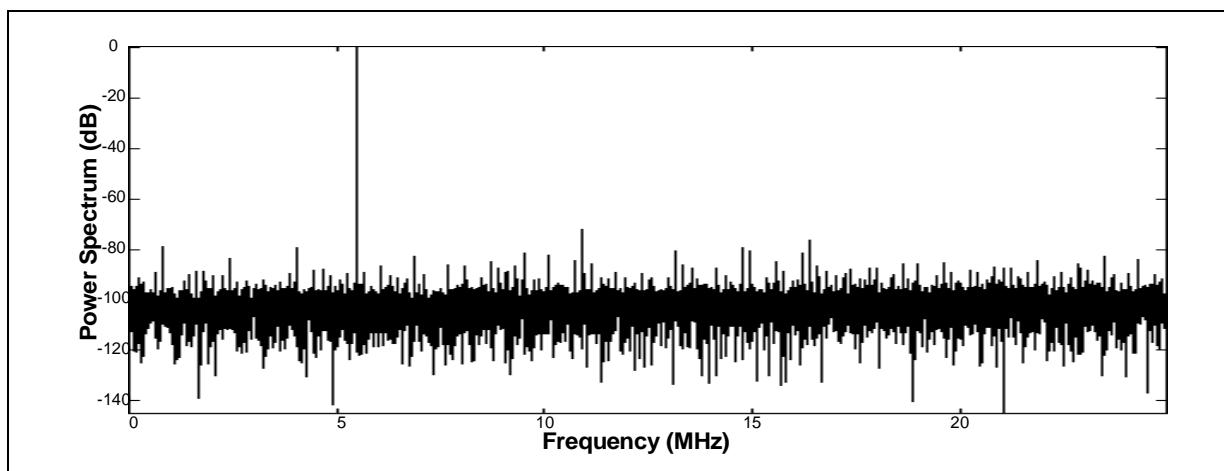
Fs=50MSPS; Icca=45mA; Fin=10MHz

**Distortion vs. VCCBE**

Fs=50MSPS; Icca=45mA; Fin=10MHz

**Single-tone 16K FFT at 50Mps**

Fin=94.5MHz; Icca=45mA, Vin@-0.5dBFS



# TSA1201 APPLICATION NOTE

## DETAILED INFORMATION

The TSA1201 is a High Speed analog to digital converter based on a pipeline architecture and the latest deep submicron CMOS process to achieve the best performances in terms of linearity and power consumption.

The pipeline structure consists of 11 internal conversion stages in which the analog signal is fed and sequentially converted into digital data.

Each 10 first stages consists of an Analog to Digital converter, a Digital to Analog converter, a Sample and Hold and a gain of 2 amplifier. A 1.5-bit conversion resolution is achieved in each stage. The latest stage simply is a comparator.

Each resulting LSB-MSB couple is then time shifted to recover from the delay caused by conversion. Digital data correction completes the processing by recovering from the redundancy of the (LSB-MSB) couple for each stage. The

corrected data are outputted through the digital buffers.

Signal input is sampled on the rising edge of the clock while digital outputs are delivered on the falling edge of the clock.

The advantages of such a converter reside in the combination of pipeline architecture and the most advanced technologies. The highest dynamic performances are achieved while consumption remains at the lowest level.

Some functionalities have been added in order to simplify as much as possible the application board. These operational modes are described in the following table.

The TSA1201 is pin to pin compatible with the 8bits/40Msps TSA0801, the 10bits/25Msps TSA1001 and the 10bits/50Msps TSA1002. This ensures a conformity within the product family and above all, an easy upgrade of the application

## OPERATIONAL MODES DESCRIPTION

Inputs			Outputs					
Analog input differential level			DFSB	OEB	SRC	OR	DR	Most Significant Bit (MSB)
(VIN-VINB)	>	RANGE	H	L	X	H	CLK	D11
-RANGE	>	(VIN-VINB)	H	L	X	H	CLK	D11
RANGE>	(VIN-VINB)	>-RANGE	H	L	X	L	CLK	D11
(VIN-VINB)	>	RANGE	L	L	X	H	CLK	D11 Complemented
-RANGE	>	(VIN-VINB)	L	L	X	H	CLK	D11 Complemented
RANGE>	(VIN-VINB)	>-RANGE	L	L	X	L	CLK	D11 Complemented
X			X	H	X	HZ	HZ	HZ
X			X	X	H	X	CLK	25Msps compliant slew rate
X			X	X	L	X	CLK	50Msps compliant slew rate

### Data Format Select (DFSB)

When set to low level (VIL), the digital input DFB provides a two's complement digital output MSB. This can be of interest when performing some further signal processing.

When set to high level (VIH), DFB provides a standard binary output coding.

### Output Enable (OEB)

When set to low level (VIL), all digital outputs remain active and are in low impedance state. When set to high level (VIH), all digital outputs buffers are in high impedance state while the converter goes on sampling. When OEB is set to a low level again, the data are then present on the output with a very short Ton delay.

Therefore, this allows the chip select of the device. The timing diagram summarizes this functionality.

**Slew Rate Control (SRC)**

When set to high level (VIH), all digital outputs currents are limited to a clamp value so that digital noise power is reduced to its minimum. Rise and fall times just match 25MHz sampling rate assuming the load capacitance on each digital output remains below 10pF.

When set to low level (VIL), the maximum digital output current increases so that rise and fall times just match the 50MHz sampling rate assuming the load capacitance on each digital output remains below 10pF.

**Out of Range (OR)**

This function is implemented on the output stage in order to set up an "Out of Range" flag whenever the digital data is over the full scale range.

Typically, there is a detection of all the data being at '0' or all the data being at '1'. This ends up with an output signal OR which is in low level state (VOL) when the data stay within the range, or in high level state (VOH) when the data are out of the range.

**Data Ready (DR)**

The Data Ready output is an image of the clock being synchronized on the output data (D0 to D11). This is a very helpful signal that simplifies the synchronization of the measurement equipment or the controlling DSP.

As digital output, DR goes into high impedance state when OEB is asserted to high level as described in the timing diagram.

**REFERENCES AND COMMON MODE CONNECTION**

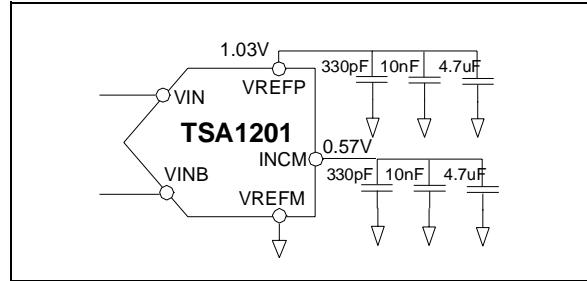
It is advised to always connect VREFM externally.

**Internal reference and common mode**

In the default configuration, the ADC operates with its own reference and common mode voltages generated by its internal bandgap. VREFM pin is connected externally to the Analog Ground while VREFP (respectively INCM) is set to its internal voltage of 1.03V (respectively 0.57V). It is recommended to decouple the VREFP in order to

minimize low and high frequency noise (refer to Figure 1)

**Figure 1 : Internal reference and common mode setting**

**External reference and common mode**

Each of the voltages VREFM, VREFP and INCM can be fixed externally to better fit to the application needs (Refer to table 'OPERATING CONDITIONS' page 2 for min/max values).

The VREFP, VREFM voltages set the analog dynamic at the input of the converter that has a full scale amplitude of  $2 \times (VREFP - VREFM)$ .

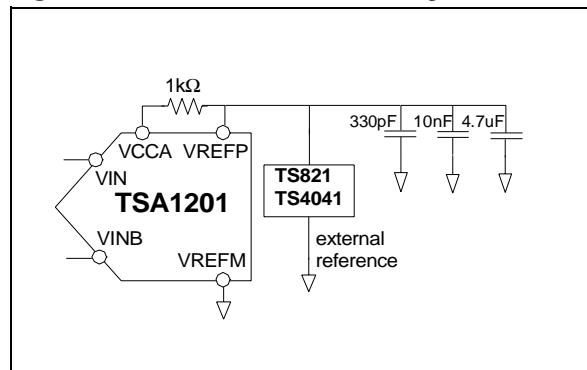
In case of analog dynamic lower than 2Vpp, the best linearity and distortion performance is achieved while increasing the VREFM voltage instead of lowering the VREFP one.

The INCM is the mid voltage of the analog input signal.

It is possible to use an external reference voltage device for specific applications requiring even better linearity, accuracy or enhanced temperature behavior.

Using the STMicroelectronics TS821 or TS4041-1.2 Vref leads to optimum performances when configured as shown on Figure 2.

**Figure 2 : External reference setting**



This can be very helpful for example for multichannel application to keep a good matching among the sampling frequency range.

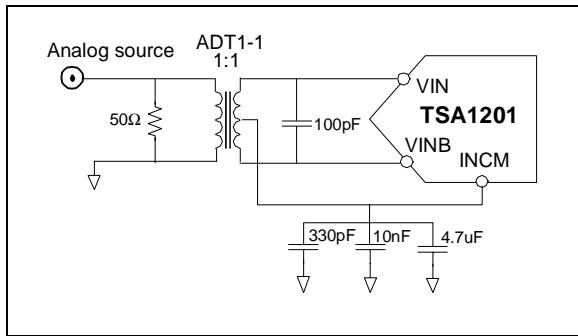
## DRIVING THE ANALOG INPUT

### Differential inputs

The TSA1201 has been designed to obtain optimum performances when being differentially driven. An RF transformer is a good way to achieve such performances.

Figure 3 describes the schematics. The input signal is fed to the primary of the transformer, while the secondary drives both ADC inputs.

**Figure 3 :** Differential input configuration with transformer



The common mode voltage of the ADC (INCM) is connected to the center-tap of the secondary of the transformer in order to bias the input signal around this common voltage, internally set to 0.57V. The INCM is decoupled to maintain a low noise level on this node. Our evaluation board is mounted with a 1:1 ADT1-1WT transformer from Minicircuits. You might also use a higher impedance ratio (1:2 or 1:4) to reduce the driving requirement on the analog signal source. For example, with internal references, each analog input can drive a 1Vpp amplitude input signal, so the resultant differential amplitude is 2Vpp.

**Figure 4 :** AC-coupled differential input

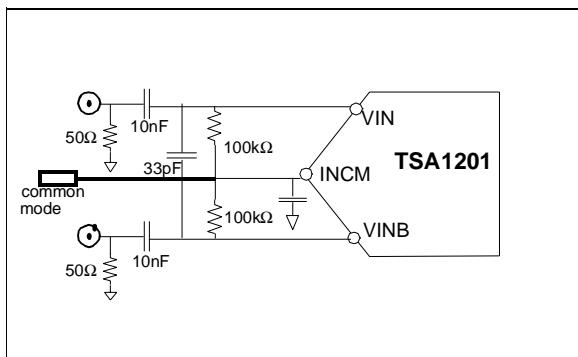
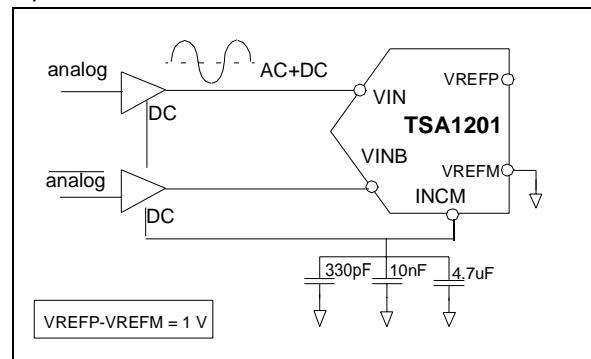


Figure 4 represents the biasing of a differential input signal in AC-coupled differential input configuration. Both inputs VIN and VINB are centered around the common mode voltage, that can be let internal or fixed externally.

Figure 5 shows a DC-coupled configuration with forced INCM to the DC analog input (mid-voltage) while VREFM is connected to ground and VREFP is let internal (1V); we achieve a 2Vpp differential amplitude.

**Figure 5 :** DC-coupled 2Vpp differential analog input

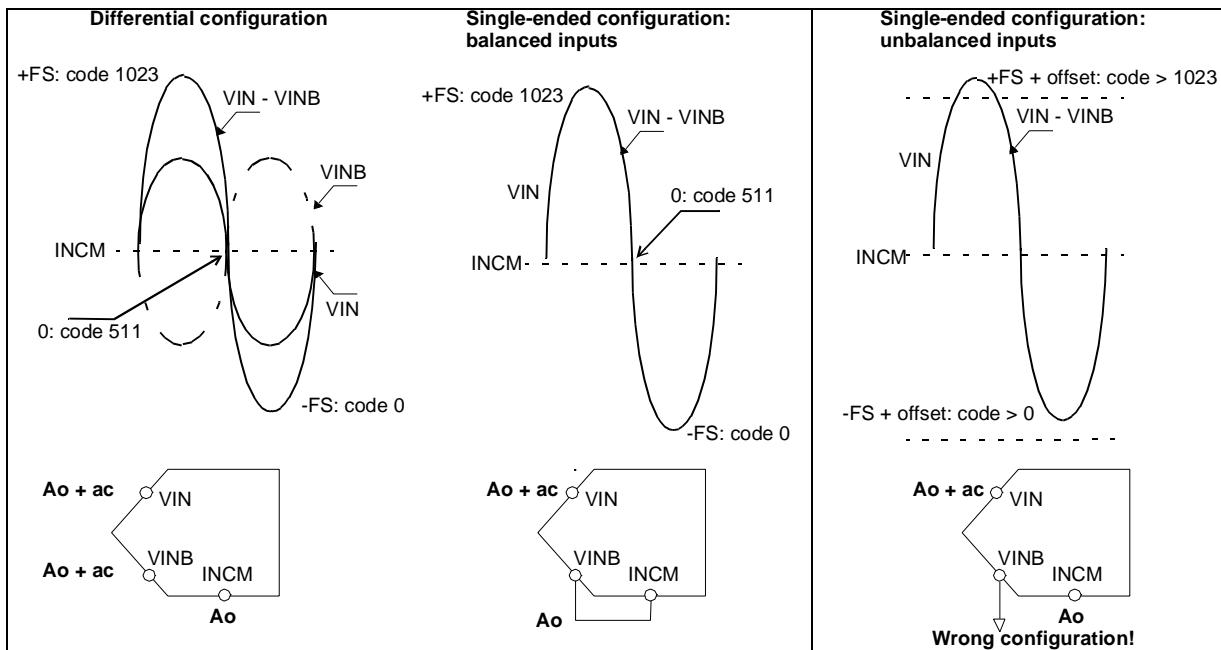


### Single-ended input configuration

The single-ended input configuration of the TSA1201 requires particular biasing and driving. The structure being fully differential, care has to be taken in order to properly bias the inputs in single-ended mode. Figure 6 summarizes the link from the differential configuration to the single-ended one; a wrong configuration is also presented.

- With differential driving, both inputs are centered around the INCM voltage.
- The transition to single-ended configuration implies to connect the unused input (VINB for instance) to the DC component of the single input (VIN) and also to the input common mode in order to be well balanced. The mid-code is achieved at the crossing between VIN and VINB, therefore inputs are conveniently biased.
- Unlike other structures of converters in which the unused channel can be grounded; in our case it will end with unbalanced inputs and saturation of the internal amplifiers leading to a non respect of the output codes.

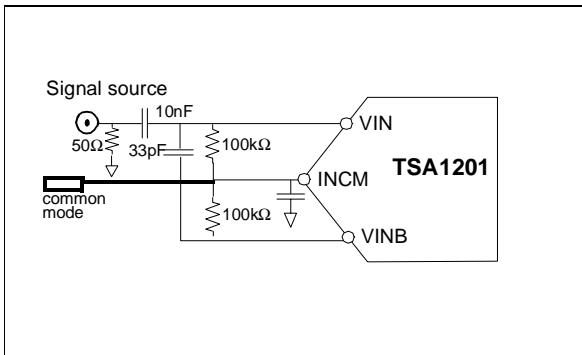
**Figure 6 : Input dynamic range for the various configurations**



The applications requiring single-ended inputs can be configured like reported on Figure 7 for an AC-coupled input or on Figure 8 and 9 for a DC-coupled input.

In the case of AC-coupled analog input, the analog inputs VIN and VINB are biased to the same voltage that is the common mode voltage of the circuit (INCM). The INCM and reference voltages may remain at their internal level but can also be fixed externally.

**Figure 7 : AC-coupled Single-ended input**



In the case of DC-coupled analog input with 1V DC signal, the DC component of the analog input set the common mode voltage. As an example figure 8, INCM is set to the 1V DC analog input while VREFM is connected to ground and VREFP

let internal; we achieve a 2Vpp differential amplitude.

**Figure 8 : DC-coupled 2Vpp analog input**

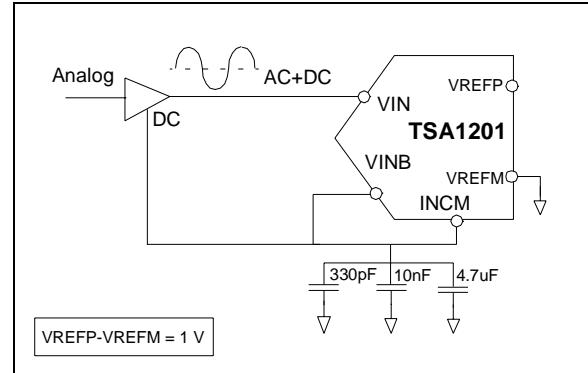
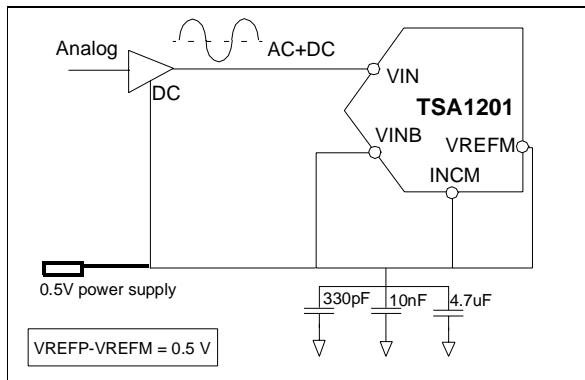


Figure 9 describes a configuration for a 1Vpp analog signal with a 0.5V DC input. In this case, while VREFP is kept internal at 1V, VREFM is connected to VINB and INCM, externally to 0.5V; the dynamic is then 1Vpp (VREFP-VREFM=0.5V).

**Figure 9 : DC-coupled 1Vpp analog input**

Dynamic characteristics, while not being as remarkable as for differential configuration, are still of very good quality. Measurements done at 50Msps, 2MHz input frequency, -1dBFS input level sum up these performances. A SNR of 63.5dB and an ENOB full Scale of 10.2 bits are achieved.

### IF-sampling

Software radio has become a common mode for receiving data through RF receivers. Its main advantage being to digitally implement what was originally done with analog functions such as discriminators, demodulation and filtering.

Originally, bipolar process was mainly used because they provided high transistor transit frequency, while pure CMOS technology showed a lower one. With new CMOS process and circuit topology, higher frequencies are now achieved.

The TSA1201 has been specifically designed to meet the requirement of sampling at Intermediate Frequency. For this purpose, the Track-and-Hold of the first pipeline stage has been built to ensure the global linearity of the overall ADC to perform the right characteristics.

Our proprietary Track-and-Hold has a patented switch control system to enable the performances not to be degraded as input signal frequency increases.

As a result, an analog bandwidth of 1GHz is achieved.

### Clock input

The converter quality is very dependant on clock input accuracy, in terms of aperture jitter; the use of low jitter crystal controlled oscillator is recommended.

The duty cycle must be between 45% and 55%.

The clock power supplies must be separated from the ADC output ones to avoid digital noise modulation at the output.

It is recommended to always keep the circuit clocked, to avoid random states, before applying the supply voltages.

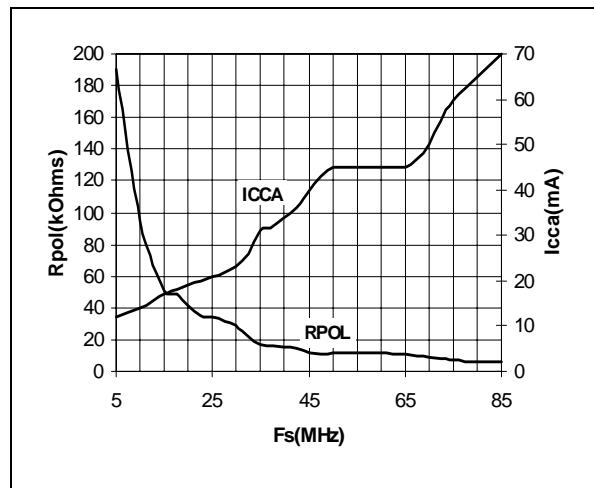
### Power consumption optimization

The internal architecture of the TSA1201 enables to optimize the power consumption according to the sampling frequency of the application. For this purpose, a resistor is placed between IPOL and the analog Ground pins.

The TSA1201 will combine highest performances and lowest consumption at 50Msps when Rpol is equal to 12kΩ.

At lower sampling frequency, this value of resistor may be changed and the consumption will decrease as well.

The figure 10 sums up the relevant data.

**Figure 10 : Analog Current consumption vs. Fs According value of Rpol polarization resistance**

### Layout precautions

To use the ADC circuits in the best manner at high frequencies, some precautions have to be taken for power supplies:

- First of all, the implementation of 4 separate proper supplies and ground planes (analog, digital, internal and external buffer ones) on the PCB is recommended for high speed circuit applications to provide low inductance and low resistance common return.

The separation of the analog signal from the digital part is essential to prevent noise from coupling onto the input signal.

- Power supply bypass capacitors must be placed as close as possible to the IC pins in order to

improve high frequency bypassing and reduce harmonic distortion.

- Proper termination of all inputs and outputs is needed; with output termination resistors, the amplifier load will be only resistive and the stability of the amplifier will be improved. All leads must be wide and as short as possible especially for the analog input in order to decrease parasitic capacitance and inductance.

- To keep the capacitive loading as low as possible at digital outputs, short lead lengths of routing are essential to minimize currents when the output changes. To minimize this output capacitance, buffers or latches close to the output pins will relax this constraint.

- Choose component sizes as small as possible (SMD).

### EVAL1201 evaluation board

The characterization of the board has been made with a fully ADC devoted test bench as shown on Figure 11. The analog signal must be filtered to be very pure.

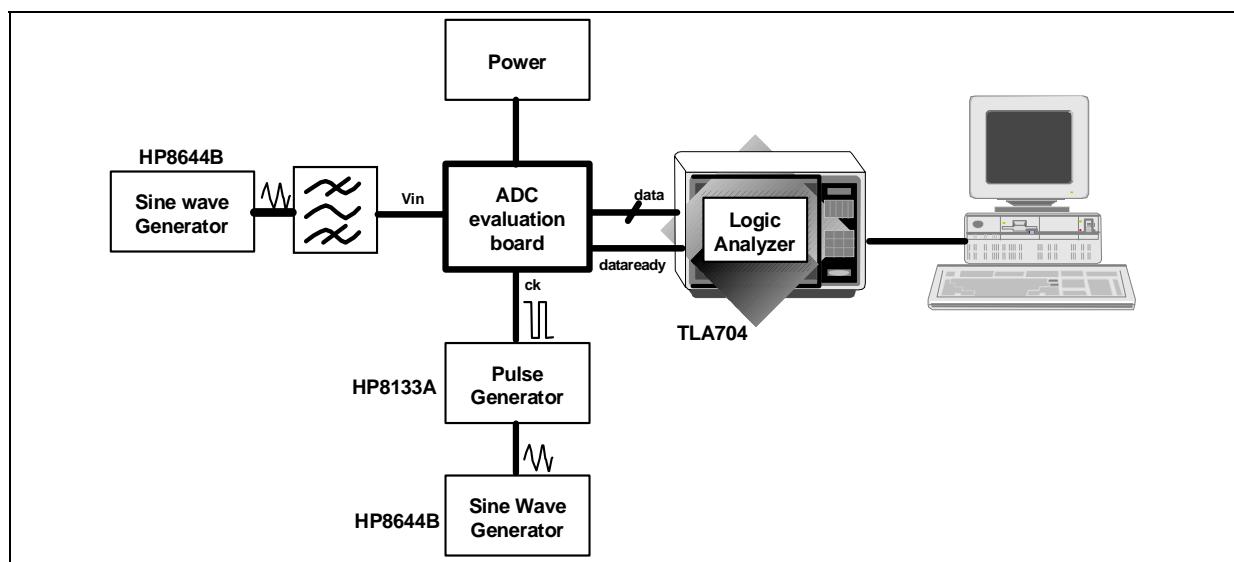
The dataready signal is the acquisition clock of the logic analyzer.

The ADC digital outputs are latched by the octal buffers 74LCX573.

All characterization measurements have been made with:

- SFSR=+0.5dB for static parameters.
- SFSR=-0.5dB for dynamic parameters.

**Figure 11 :** Analog to Digital Converter characterization bench



**Figure 12 : TSA1201 Evaluation board schematic**

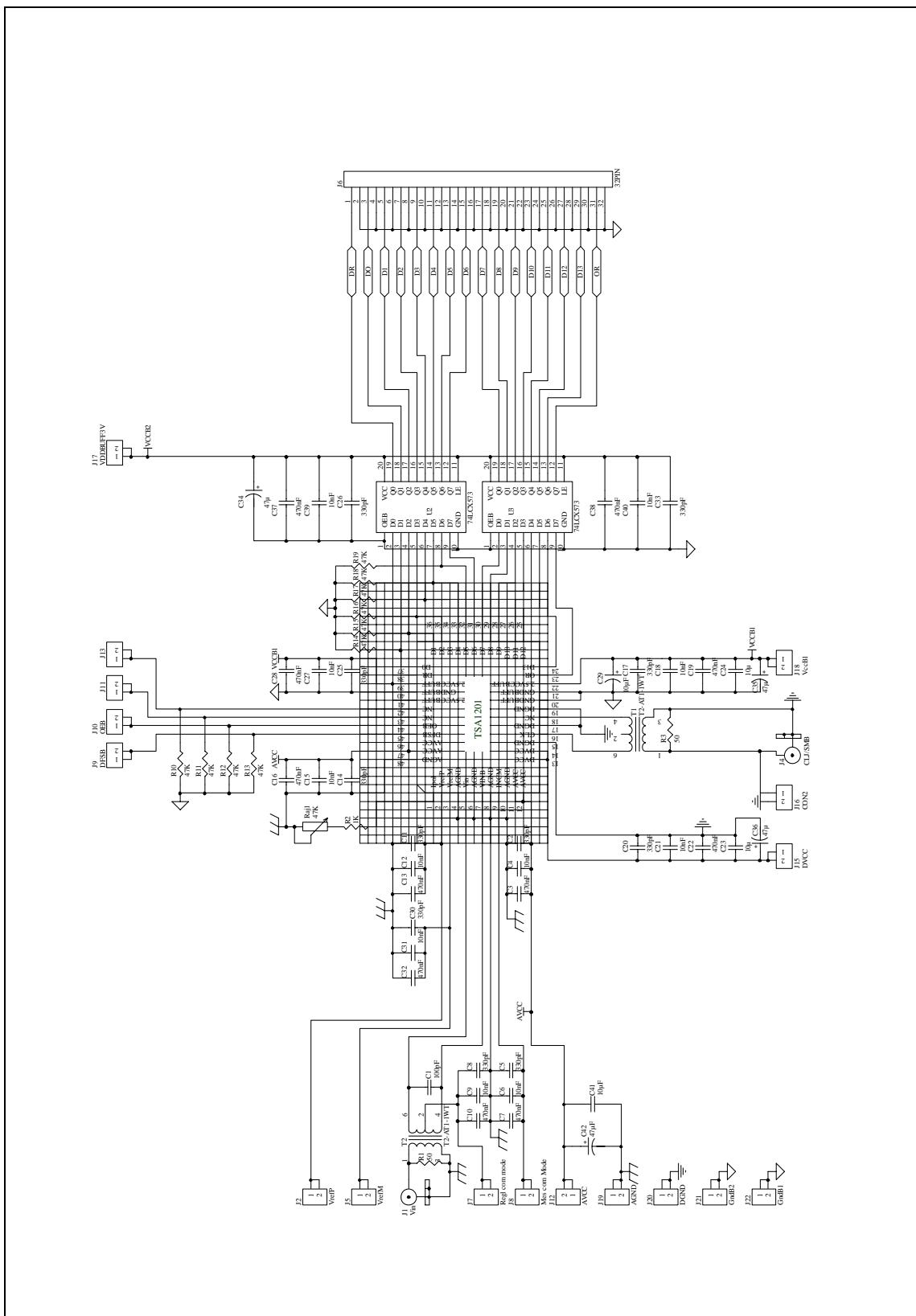
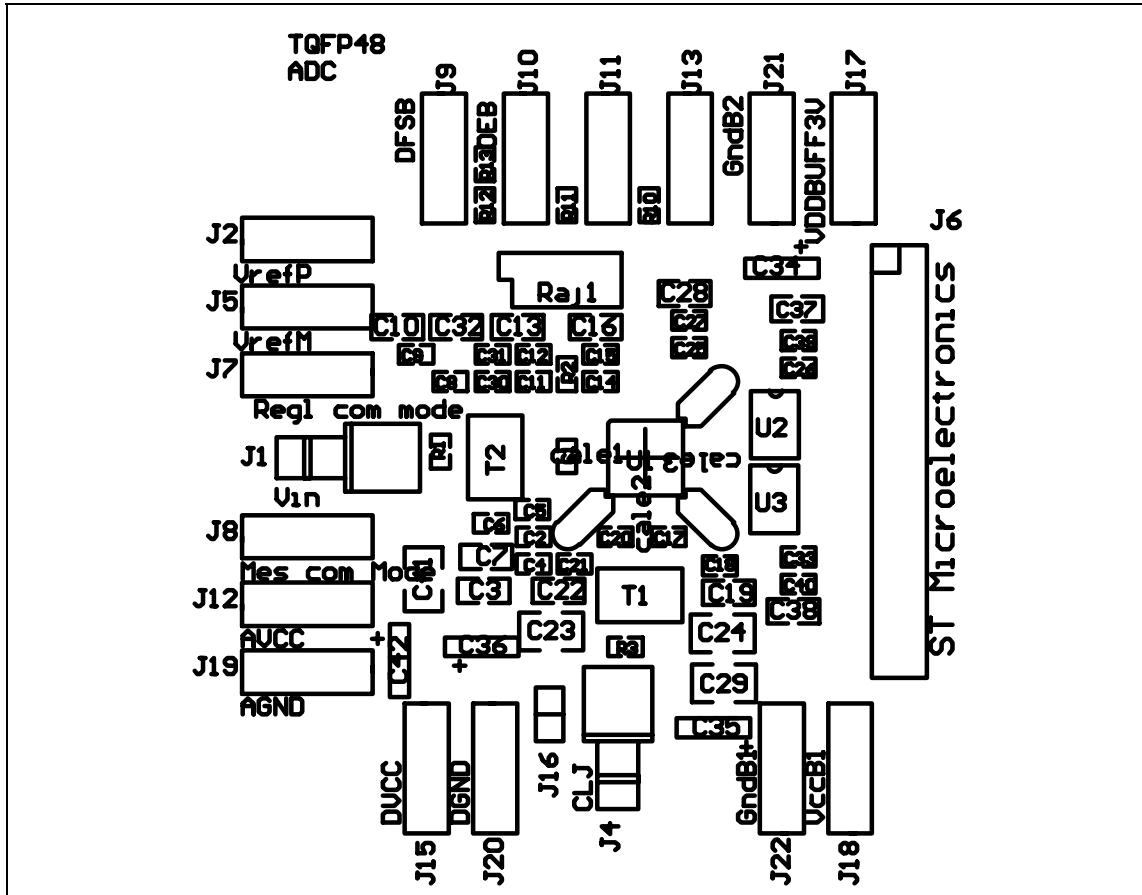
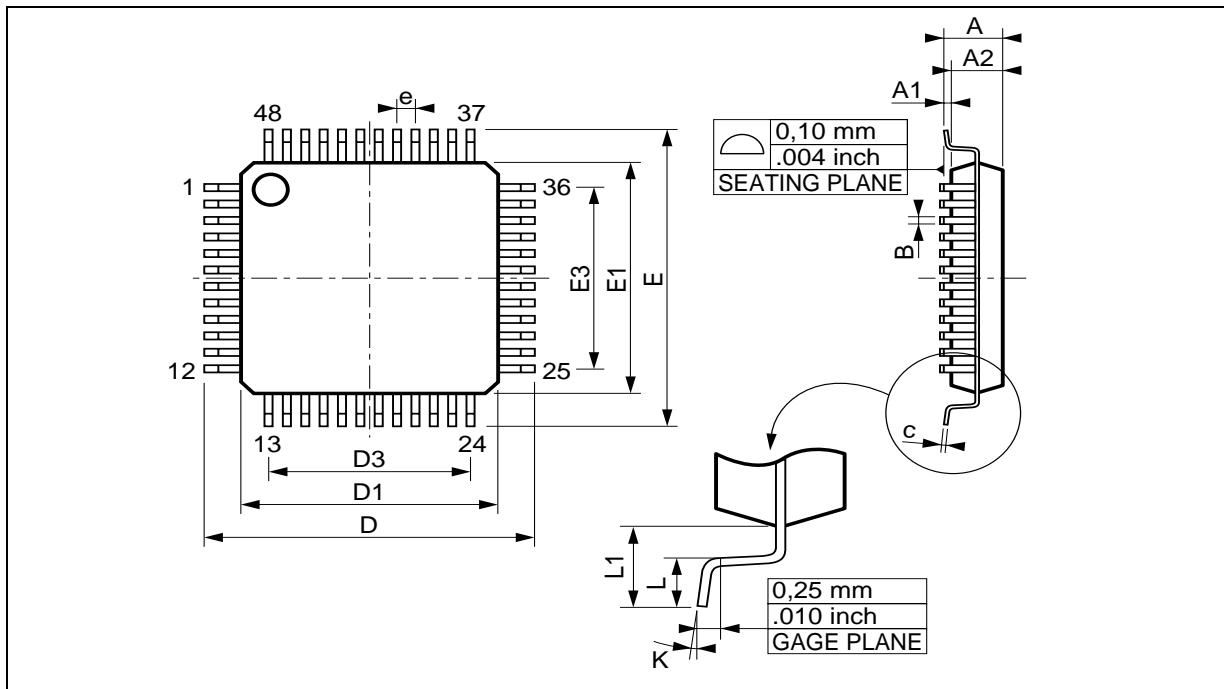


Figure 13 : Printed circuit of evaluation board.



**PACKAGE MECHANICAL DATA**  
48 PINS - PLASTIC PACKAGE



Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.60			0.063
A1	0.05		0.15	0.002		0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
B	0.17	0.22	0.27	0.007	0.009	0.011
C	0.09		0.20	0.004		0.008
D		9.00			0.354	
D1		7.00			0.276	
D3		5.50			0.216	
e		0.50			0.0197	
E		9.00			0.354	
E1		7.00			0.276	
E3		5.50			0.216	
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1.00			0.039	
K	0° (min.), 7° (max.)					

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